Hyperfast Diode

30 A, 400 V - 600 V

RHRG3040, RHRG3060

Description

The RHRG3040, RHRG3060 is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Features

- Hyperfast Recovery $t_{rr} = 45 \text{ ns}$ (@ $I_F = 30 \text{ A}$)
- Max Forward Voltage, $V_F = 2.1 \text{ V}$ (@ $T_C = 25^{\circ}\text{C}$)
- 400 V, 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

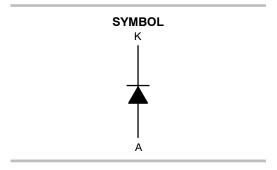


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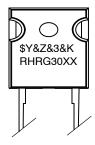
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TO-247-2LD CASE 340CL



MARKING DIAGRAM



= ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code &K = Lot Code

RHRG30XX = Specific Device Code

= 40.60XX

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

RHRG3040, RHRG3060

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

Parameter	Symbol	RHRG3040	RHRG3060	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	400	600	V
Working Peak Reverse Voltage	V _{RWM}	400	600	V
DC Blocking Voltage	V _R	400	600	V
Average Rectified Forward Current (T _C = 120°C)	I _{F(AV)}	30	30	Α
Repetitive Peak Surge Current (Square Wave, 20 kHz)	I _{FRM}	70	70	Α
Non-repetitive Peak Surge Current (Halfwave, 1 Phase, 60 Hz)	I _{FSM}	325	325	Α
Maximum Power Dissipation	P _D	125	125	W
Avalanche Energy (See Figures 10 and 11)	E _{AVL}	20	20	mJ
Operating and Storage Temperature	T _{STG} , T _J	-65 to 175	-65 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Shipping
RHRG3040	RHRG3040	TO-247-2LD	450 / Tube
RHRG3060	RHRG3060	TO-247-2LD	450 / Tube

ELECTRICAL SPECIFICATION (T_C = 25°C, unless otherwise specified)

			RHRG3040		RHRG3060				
Characteristics	Symbol	Test Condition	Min	Тур	Max	Min	Тур	Max	Unit
Instantaneous Forward Voltage	V _F	I _F = 30 A	_	-	2.1	-	-	2.1	V
(Pulse Width = 300 μs, Duty Cycle = 2%)		I _F = 30 A, T _C = 150°C	-	-	1.7	-	-	1.7	V
Instantaneous Reverse Current	I _R	V _R = 400 V	_	-	250	-	-	_	μΑ
		V _R = 600 V	-	-	-	-	-	250	μΑ
		V _R = 400 V, T _C = 150°C	-	-	1.0	-	-	-	mA
		V _R = 600 V, T _C = 150°C	-	-	-	-	-	1.0	mA
Reverse Recovery Time	t _{rr}	$I_F = 1 \text{ A, } dI_F/dt = 200 \text{ A}/\mu\text{s}$	-	-	40	-	-	40	ns
(See Figure 9) Summation of t _a + t _b		$I_F = 30 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$	-	-	45	-	-	45	ns
Time to Reach Peak Reverse Current (See Figure 9)	t _a	$I_F = 30 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$	-	22	-	-	22	_	ns
Time from Peak I _{RM} to Projected Zero Crossing of I _{RM} Based on a Straight Line from Peak I _{RM} through 25% of I _{RM} (See Figure 9)	t _b	$I_F = 30 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$	-	18	-	-	18	-	ns
Reverse Recovery Charge	Q _{rr}	$I_F = 30 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$	-	100		-	100	-	nC
Junction Capacitance	CJ	V _R = 10 V, I _F = 0 A	-	85		-	85	-	pF
Thermal Resistance Junction to Case	$R_{ heta JC}$		-	_	1.2	_	_	1.2	°C/W

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

RHRG3040, RHRG3060

TYPICAL PERFORMANCE CURVES

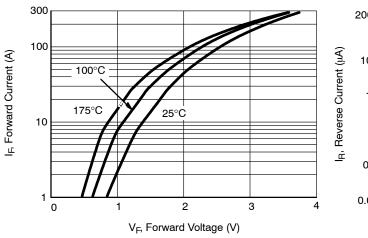
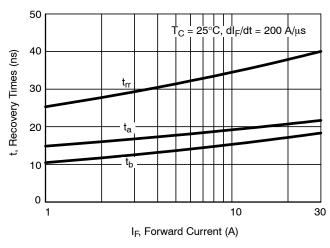


Figure 1. Forward Current vs. Forward Voltage

Figure 2. Reverse Current vs. Reverse Voltage



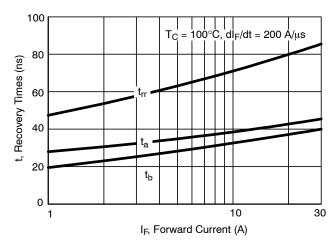
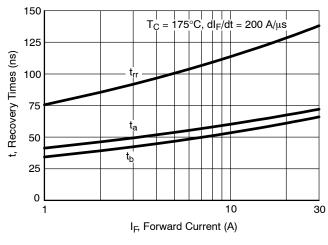


Figure 3. t_{rr} , t_a and t_b Curves vs. Forward Current

Figure 4. t_{rr} , t_a and t_b Curves vs. Forward Current



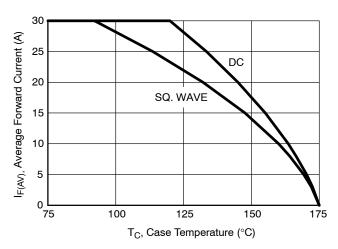


Figure 5. t_{rr} , t_a and t_b Curves vs. Forward Current

Figure 6. Current Derating Curve

RHRG3040, RHRG3060

TYPICAL PERFORMANCE CURVES (continued)

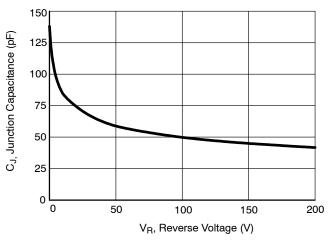


Figure 7. Junction Capacitance vs. Reverse Voltage

TEST CIRCUITS AND WAVEFORMS

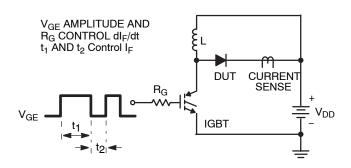


Figure 8. t_{rr} Test Circuit

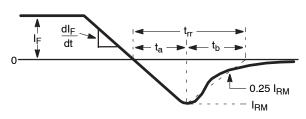


Figure 9. t_{rr} Waveforms and Definitions

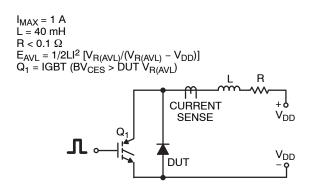


Figure 10. Avalanche Energy Test Circuit

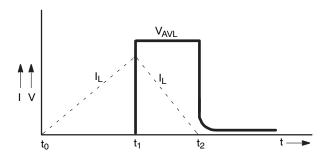
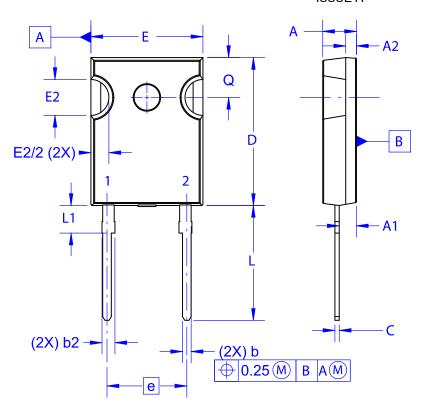


Figure 11. Avalanche Current and Voltage Waveforms

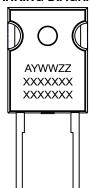
TO-247-2LD CASE 340CL **ISSUE A**





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
 D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

= Assembly Location

= Year

WW = Work Week

= Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

	DATE 03 DEC 2019			
Ø P —		Ø P1 D2		
E1 —	1	D1		
,		9		

DIM	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
A1	2.29	2.40	2.66		
A2	1.30	1.50	1.70		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
С	0.51	0.61	0.71		
D	20.32	20.57	20.82		
D1	16.37	16.57	16.77		
D2	0.51	0.93	1.35		
Е	15.37	15.62	15.87		
E1	12.81	l	~		
E2	4.96	5.08	5.20		
е	~	11.12	~		
L	15.75	16.00	16.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
Ø P 1	6.61	6.73	6.85		
Q	5.34	5.46	5.58		
5	5.34	5.46	5.58		

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